



--	--	--	--



FSBREC H62 (SMD)

fi

FSBREC H62 1!+02&!\$fi

With built-in bias resistors, simplify circuit design, reduce a quantity of parts and manufacturing process, HF Product.

FSBREC H62 //3#'+0#(-\$fi fi

Switching applications, interface circuit and driver circuit applications.

FSBREC H62 42#" +3! - 0fi ` #&' 2#0fi



FSBREC H62 5#- -#- . fi



PIN 1 IN PIN 2 GND PIN 3 OUT

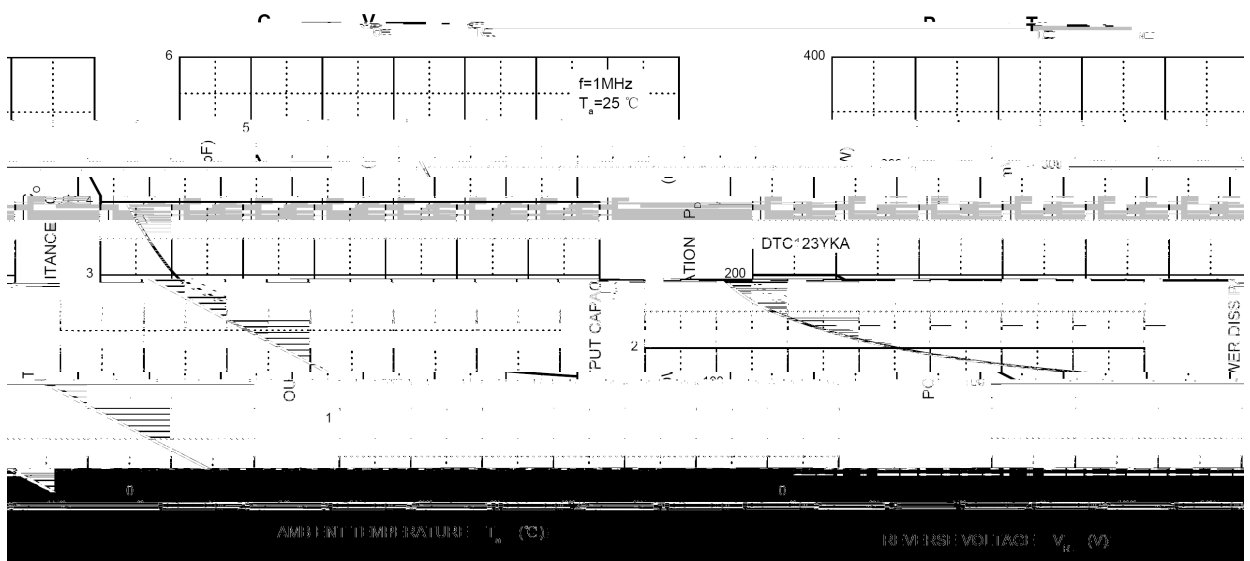
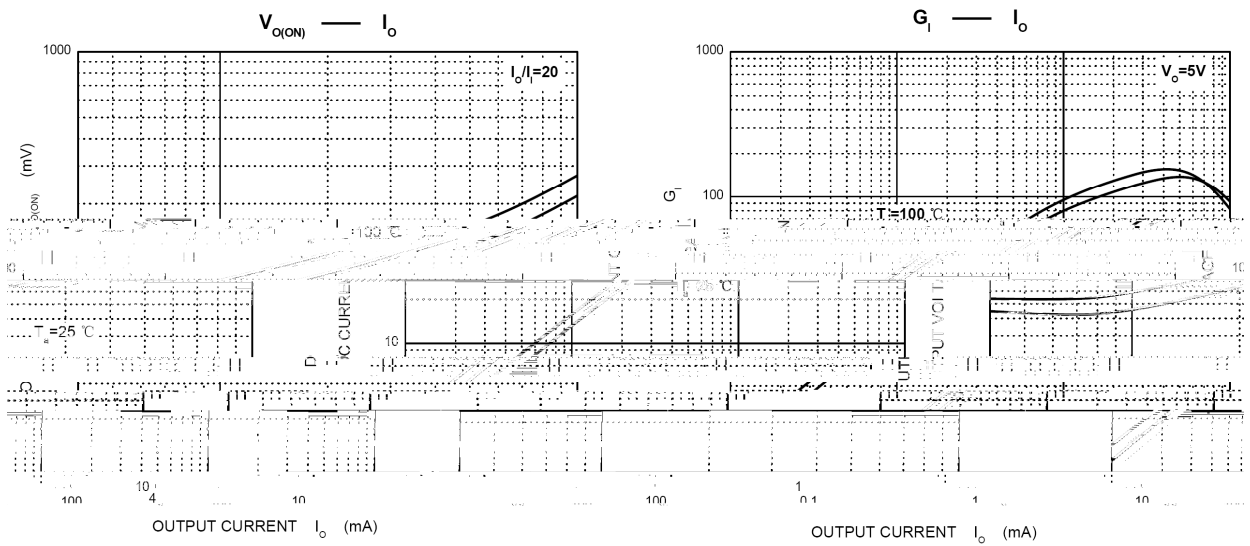
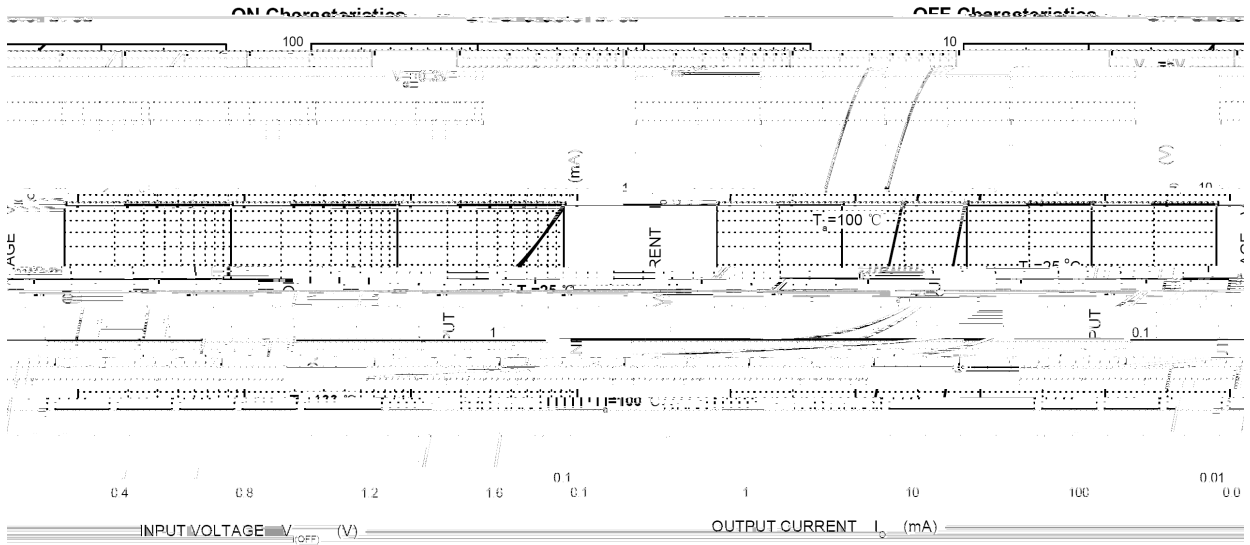
FSBREC H62 \* +&, #- . fi

Marking	H62
---------	-----



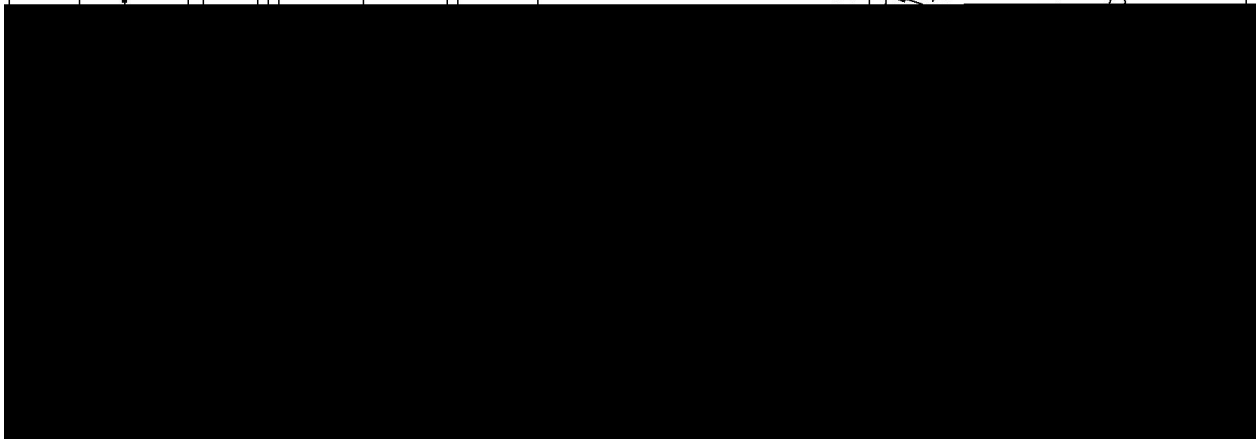
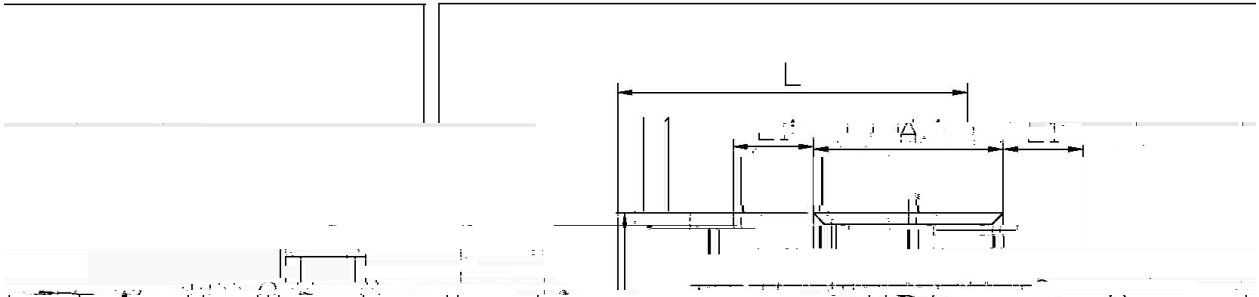


fi fi Žfi fi †3! '0&#' +3fi ' =+&+ '0!&#S0#' fi ' 2&" !fi





fi fi fi fi 5+' ,+. !fi #8 !-\$#(- \$fi







9 温度曲线 Temperature Profile for IR Reflow Soldering(Pb-Free)


Note:

- |   |         |           |  |
|---|---------|-----------|--|
| 1 | 150 180 | 60 90sec; | 1.Preheating:150~180°C, Time:60~90sec.   |
| 2 | 245±5   | 5±0.5sec; | 2.Peak Temp.:245±5°C, Duration:5±0.5sec. |
| 3 | 2       | 10°C/sec. | 3. Cooling Speed: 2~10°C/sec.            |

温度曲线 260±5°C 10±1 sec. Temp.:260±5°C Time:10±1 sec

260±5°C                      10±1 sec.                      Temp.:260±5°C                      Time:10±1 sec

温度曲线 5+ , +. # - . 15 ± 0.5

/ REEL

( 12.808( ))TJ ET, 3686.04 353.01 m3686.04 42629 | 53764 42629 53764 353.01 | h W\* n BT58.04 0 0581400 Tm /F8 1 Tf 0 0 0 sc 0 0 0 SC 0 Tr 013.47869.237  
Package type 封装形式